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|   | Filing Date            |      | 2003-09-29  |  |
|   | First Named Inventor   | PETT | AY, Mark J. |  |
|   | Art Unit               |      | 2626        |  |
|   | Examiner Name          | YEN, | Eric L.     |  |
|   | Attorney Docket Number | er   | PAT-008A    |  |

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